



Title of Change:	Throughput Improvement of FDMF3180	
Effective date:	19 Nov 2021	
Contact information:	Contact your local ON Semiconductor Sales Office or Ravi.Savanur@onsemi.com	
Type of notification:	This Product Bulletin is for notification purposes only. ON Semiconductor will proceed with implementation of this change upon publication of this Product Bulletin.	
Change Category:	Manufacturing Improvement	
Change Sub-Category(s):	Product specific change	
Sites Affected:		
ON Semiconductor Sites	External Foundry/Subcon Sites	
None	None	
Description and Purpose:		
Silicon revision to improve the manufacturability and yields by optimizing the trim range of the driver IC.		
There is no change to the product material, performance, or datasheet specifications. Only the top mark will change as noted in the table below.		
	From	To
Product marking change	XXXXXXX FDMF 3180 B6	XXXXXXX FDMF 3180 B7
List of Affected Standard Parts:		
Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the PCN Customized Portal .		
FDMF3180		